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ICS853L022
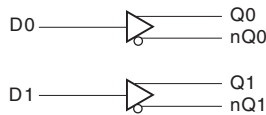## DUAL LVCMOS / LVTTL-TO-DIFFERENTIAL 3.3V LVPECL TRANSLATOR

GENERAL DESCRIPTION

The ICS853L022 is a Dual LVCMOS / LVTTL-to-Differential 3.3V LVPECL translator and a member of the HiPerClocks™ family of High Performance Clocks Solutions from ICS. The ICS853L022 has single ended clock inputs. The single ended clock input accepts LVCMOS or LVTTL input levels and translate them to LVPECL levels. The small outline 8-pin TSSOP package makes this device ideal for applications where space, high performance and low power are important.

FEATURES

- 2 differential LVPECL outputs

- LVCMOS/LVTTL clock inputs

- Output frequency: 350MHz (typical)

- Part-to-part skew: 400 (maximum)

- Propagation Delay: 450ps (typical)

- Additive phase jitter, RMS: 0.03ps (typical)

- LVPECL mode operating voltage supply range:
  $V_{CC} = 3.0V$ to $3.8V$, $V_{EE} = 0V$

- ECL mode operating voltage supply range:
  $V_{CC} = 0V$, $V_{EE} = -3.8V$ to $-3.0V$

- -40°C to 85°C ambient operating temperature

- Lead-Free package RoHS compliant

BLOCK DIAGRAM

PIN ASSIGNMENT
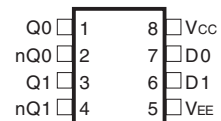
ICS853L022
8-Lead TSSOP, 118 mil
3mm x 3mm x 0.95mm package body
G Package
Top View

8-Lead SOIC, 150 mil
3.90mm x 4.90mm x 1.37mm package body
M Package
Top View

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 2	Q0, nQ0	Output		Differential output pair. LVPECL interface levels.
3, 4	Q1, nQ1	Output		Differential output pair. LVPECL interface levels.
5	V_{EE}	Power		Negative supply pin.
6	D1	Input		LVCMOS / LVTTL clock input.
7	D0	Input		LVCMOS / LVTTL clock input.
8	V_{CC}	Power		Positive supply pin.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{CC}	4.6V (LVPECL mode, $V_{EE} = 0$)
Negative Supply Voltage, V_{EE}	-4.6V (ECL mode, $V_{CC} = 0$)
Inputs, V_I (LVPECL mode)	-0.5V to V_{CC} + 0.5 V
Inputs, V_I (ECL mode)	0.5V to V_{EE} - 0.5V
Outputs, I_O	
Continuous Current	50mA
Surge Current	100mA
Operating Temperature Range, TA	-40°C to +85°C
Storage Temperature, T_{STG}	-65°C to 150°C
Package Thermal Impedance, θ_{JA}	101.7°C/W (0 m/s) TSSOP
(Junction-to-Ambient)	112.7°C/W (0 lfpm) SOIC

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 2A. POWER SUPPLY DC CHARACTERISTICS, V_{CC} = 3.0V TO 3.8V; V_{EE} = 0V

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{CC}	Positive Supply Voltage		3.0	3.3	3.8	V
I_{EE}	Power Supply Current				30	mA

TABLE 2B. LVCMOS/LVTTL DC CHARACTERISTICS, V_{CC} = 3.0V TO 3.8V; V_{EE} = 0V

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		0.7 * V_{CC}			V
V_{IL}	Input Low Voltage				0.3 * V_{CC}	V
I_{IH}	Input High Current	V_{CC} = V_{IN} = 3.8V			100	µA
I_{IL}	Input Low Current	V_{CC} = 3.8V, V_{IN} = 0V			-0.6	mA

TABLE 2C. LVPECL DC CHARACTERISTICS, V_{CC} = 3.3V; V_{EE} = 0V

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{OH}	Output High Voltage; NOTE 1	2.175	2.275	2.38	2.225	2.295	2.37	2.295	2.33	2.365	V
V_{OL}	Output Low Voltage; NOTE 1	1.405	1.545	1.68	1.425	1.52	1.615	1.44	1.535	1.63	V

Output parameters vary 1:1 with V_{CC}. V_{CC} can vary 3.8V to 3.0V.
NOTE 1: Outputs terminated with 50Ω to V_{CC} - 2V.

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TABLE 2D. ECL DC CHARACTERISTICS, V_{CC} = 0V; V_{EE} = -3.8V TO -3.0V

Symbol	Parameter	-40°C			25°C			85°C			Units
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{OH}	Output High Voltage; NOTE 1	-1.125	-1.025	-0.92	-1.075	-1.005	-0.93	-1.005	-0.97	-0.935	V
V_{OL}	Output Low Voltage; NOTE 1	-1.895	-1.755	-1.62	-1.875	-1.78	-1.685	-1.86	-1.765	-1.67	V
V_{PP}	Peak-to-Peak Input Voltage	150	800	1200	150	800	1200	150	800	1200	mV

Output parameters vary 1:1 with V_{CC}.
NOTE 1: Outputs terminated with 50Ω to V_{CC} - 2V.

TABLE 3. AC CHARACTERISTICS, V_{CC} = 0V; V_{EE} = -3.8V TO -3.0V OR V_{CC} = 3.0V TO 3.8V; V_{EE} = 0V

Symbol	Parameter		-40°C			25°C			85°C			Units
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{MAX}	Output Frequency			350			350			350		MHz
tp_{LH}	Propagation Delay, Low to High; NOTE 1		300	525	750	300	450	600	300	450	600	ps
$tsk(o)$	Output Skew; NOTE 2, 4			10	45		10	45		10	45	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 4				225			225			225	ps
$tjit$	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter section			0.03			0.03			0.03		ps
t_R/t_F	Output Rise/Fall Time	20% to 80%	100	325	550	100	325	550	100	325	550	ps

All parameters are measured ≤ 350MHz unless otherwise noted.
NOTE 1: Measured from the differential input crossing point to the differential output crossing point.
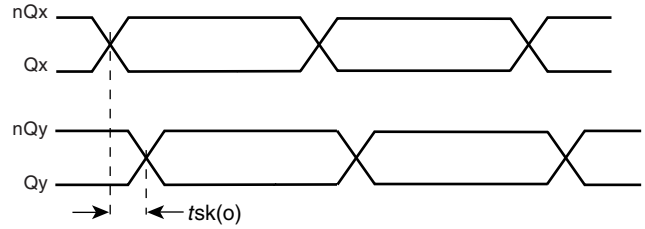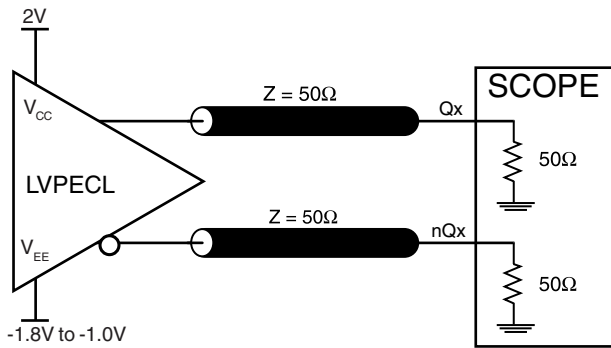NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at the output differential cross points.
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential cross points.
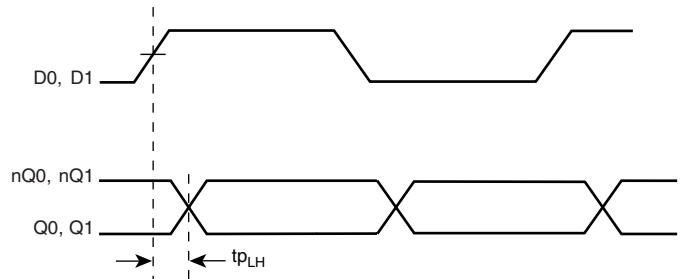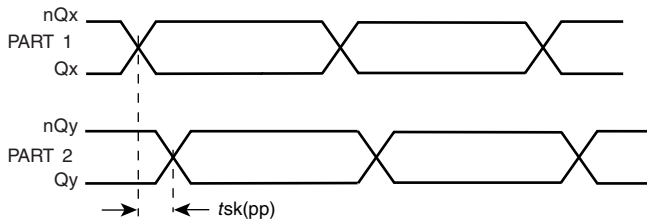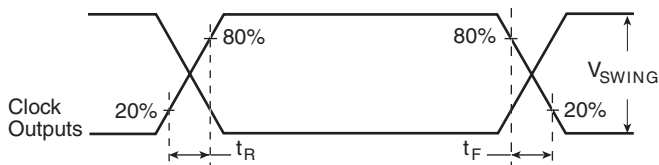NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

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PARAMETER MEASUREMENT INFORMATION

OUTPUT LOAD AC TEST CIRCUIT

$t$sk(o)

OUTPUT SKEW

$t$sk(pp)

PART-TO-PART SKEW

tp$_{LH}$

PROPAGATION DELAY

80%   80%

V$_{SWING}$

20%   20%

Clock
Outputs

t$_R$ t$_F$

OUTPUT RISE/FALL TIME

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APPLICATION INFORMATION

TERMINATION FOR 3.3V LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 1A and 1B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.
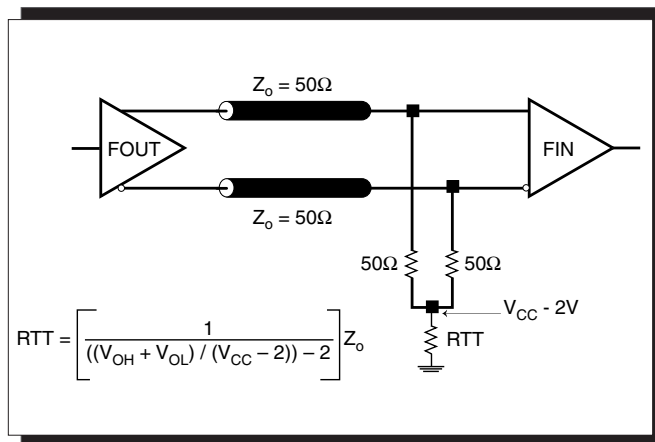

$$RTT = \left[\frac{1}{((V_{OH} + V_{OL}) / (V_{CC} - 2)) - 2} \right] Z_o$$
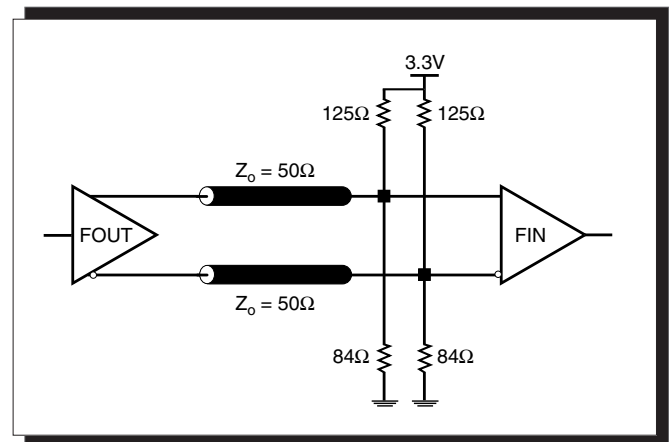
FIGURE 1A. LVPECL OUTPUT TERMINATION

FIGURE 1B. LVPECL OUTPUT TERMINATION

Power Considerations

This section provides information on power dissipation and junction temperature for the ICS853L022.
Equations and example calculations are also provided.

1. Power Dissipation.
The total power dissipation for the ICS853L022 is the sum of the core power plus the power dissipated in the load(s).
The following is the power dissipation for V_{CC} = 3.8V, which gives worst case results.
NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)$_{MAX}$ = V_{CC_MAX} * I_{EE_MAX} = 3.8V * 30mA = **114mW**

- Power (outputs)$_{MAX}$ = **30.94mW/Loaded Output pair**
  If all outputs are loaded, the total power is 2 * 30.94mW = 61.88**mW**

  Total Power$_{\_MAX}$ (3.8V, with all outputs switching) = 114mW + 61.88mW = **175.88mW**

2. Junction Temperature.
Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for Tj is as follows: $Tj = \theta_{JA}$ * Pd_total + T_A

Tj = Junction Temperature

θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 1 meters per second and a multi-layer board, the appropriate value is 90.5°C/W per Table 4A below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:
85°C + 0.176W * 90.5°C/W = 100.9°C. This is below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 4A. THERMAL RESISTANCE θ_{JA} FOR 8-PIN TSSOP, FORCED CONVECTION

θ_{JA} by Velocity (Meters per Second)			
	0	1	2
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

TABLE 4B. THERMAL RESISTANCE θ_{JA} FOR 8 LEAD SOIC

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	153.3°C/W	128.5°C/W	115.5°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	112.7°C/W	103.3°C/W	97.1°C/W
NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.			

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3. Calculations and Equations.

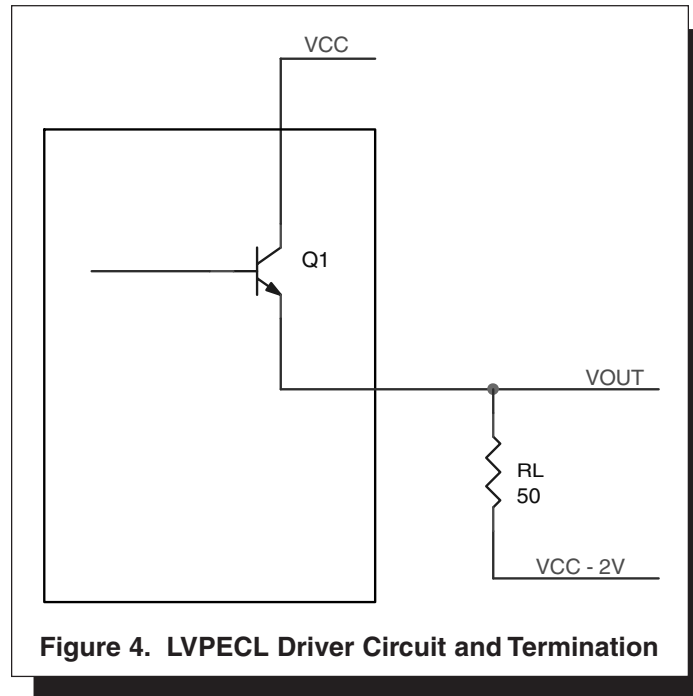LVPECL output driver circuit and termination are shown in Figure 4.

Figure 4. LVPECL Driver Circuit and Termination

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{CCO} - 2V.

- For logic high, $V_{OUT} = V_{OH\_MAX} = V_{CCO\_MAX} - 0.935V$

  $(V_{CC\_MAX} - V_{OH\_MAX}) = 0.935V$

- For logic low, $V_{OUT} = V_{OL\_MAX} = V_{CCO\_MAX} - 1.67V$

  $(V_{CCO\_MAX} - V_{OL\_MAX}) = 1.67V$

$Pd\_H = [(V_{OH\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) =$
$[(2V - 0.935V)/50Ω] * 0.935V = 19.92mW$

$Pd\_L = [(V_{OL\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) =$
$[(2V - 1.67V)/50Ω] * 1.67V = 11.02mW$

Total Power Dissipation per output pair = Pd_H + Pd_L = 30.94mW

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RELIABILITY INFORMATION

TABLE 5A. θ_{JA} VS. AIR FLOW TABLE FOR **8 LEAD TSSOP**

θ_{JA} by Velocity (Meters per Second)			
	0	**1**	**2**
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W

TABLE 5B. θ_{JA} VS. AIR FLOW TABLE FOR **8 LEAD SOIC**

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**200**	**500**
Single-Layer PCB, JEDEC Standard Test Boards	153.3°C/W	128.5°C/W	115.5°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	112.7°C/W	103.3°C/W	97.1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.
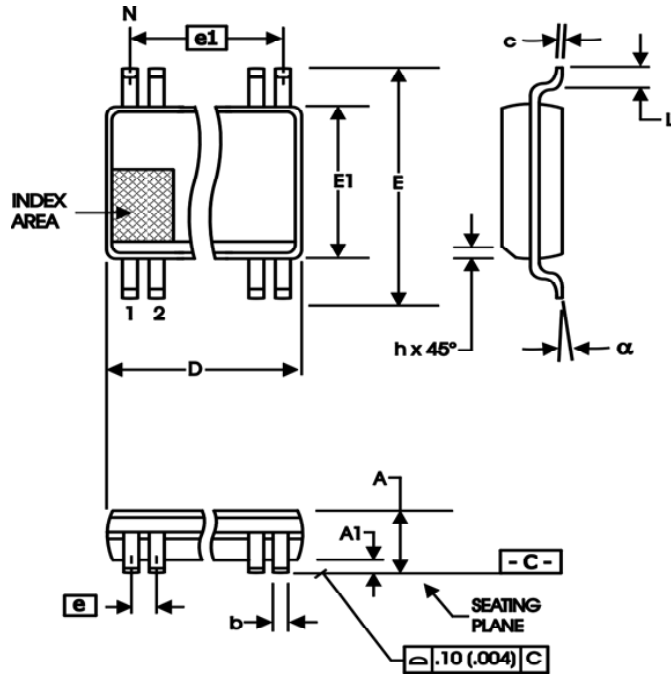
TRANSISTOR COUNT
The transistor count for ICS853L022 is: 92

Pin compatible with MC100LVELT22

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P{ackage} O{utline} - G S{uffix} {for} 8 L{ead} TSSOP

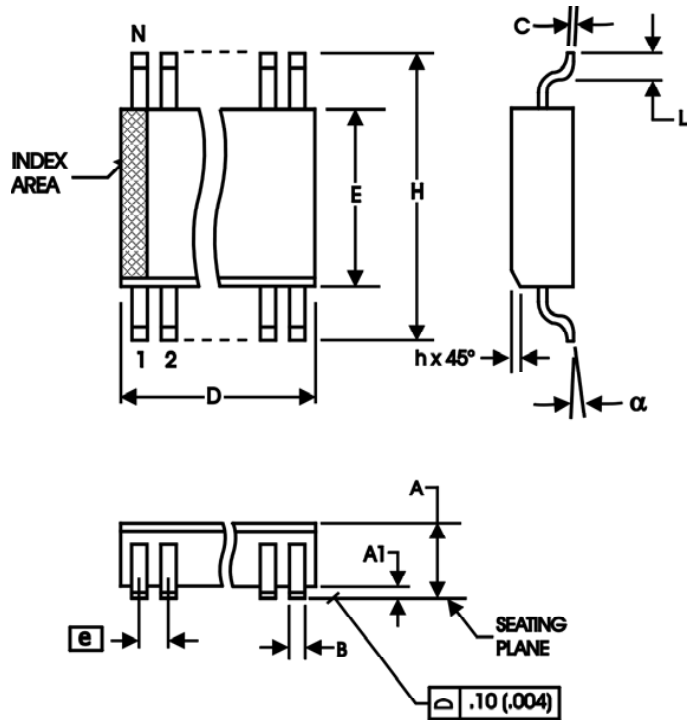**P{ackage} O{utline} - M S{uffix} {for} 8 L{ead} SOIC**

T{able} 6A. P{ackage} D{imensions}

SYMBOL	Millimeters	
	Minimum	**Maximum**
N	8	
A	--	1.10
A1	0	0.15
A2	0.79	0.97
b	0.22	0.38
c	0.08	0.23
D	3.00 BASIC	
E	4.90 BASIC	
E1	3.00 BASIC	
e	0.65 BASIC	
e1	1.95 BASIC	
L	0.40	0.80
α	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-187

T{able} 6B. P{ackage} D{imensions}

SYMBOL	Millimeters	
	MINIMUN	**MAXIMUM**
N	8	
A	1.35	1.75
A1	0.10	0.25
B	0.33	0.51
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BASIC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.27
α	0°	8°

Reference Document: JEDEC Publication 95, MS-012

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TABLE 7. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
853L022AG	022A	8 lead TSSOP	tube	-40°C to 85°C
853L022AGT	022A	8 lead TSSOP	2500 tape & reel	-40°C to 85°C
853L022AGLF	L2AL	8 lead "Lead-Free" TSSOP	tube	-40°C to 85°C
853L022AGLFT	L2AL	8 lead "Lead-Free" TSSOP	2500 tape & reel	-40°C to 85°C
853L022AM	53L022A	8 lead SOIC	tube	-40°C to 85°C
853L022AMT	53L022A	8 lead SOIC	2500 tape & reel	-40°C to 85°C
853L022AMLF	53L022AL	8 lead "Lead-Free" SOIC	tube	-40°C to 85°C
853L022AMLFT	53L022AL	8 lead "Lead-Free" SOIC	2500 tape & reel	-40°C to 85°C